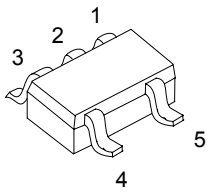
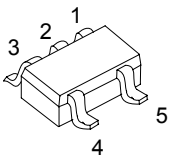
U74AHC1G66

CMOS IC

BILATERAL SWITCH



SOT-25



SOT-353

*Pb-free plating product number:
U74AHC1G66L

■ DESCRIPTION

The U74AHC1G66 is an analog switch which transmits signals from pin(Y or Z) to pin (Z or Y) with an active HIGH enable input pin (E). When pin E is LOW, the switch is turned off.

■ FEATURES

* Operation voltage range: 2~5.5V
* Low power dissipation
* Very low ON-resistance: 26Ω (typ.) at Vcc=3.0V
  16Ω (typ.) at Vcc=4.5V
  14Ω (typ.) at Vcc=5.5V

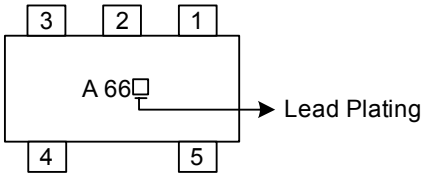
■ ORDERING INFORMATION

Order Number		Package	Packing
Normal	Lead Free Plating		
U74AHC1G66-AF5-R	U74AHC1G66L-AF5-R	SOT-25	Tape Reel
U74AHC1G66-AL5-R	U74AHC1G66L-AL5-R	SOT-353	Tape Reel

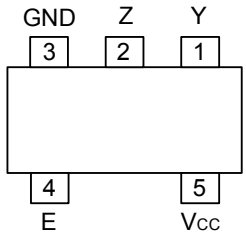
U74AHC1G66L-AF5-R
(1)Packing Type
(2)Package Type
(3)Lead Plating

(1) R: Tape Reel
(2) AF5: SOT-25, AL5: SOT-353
(3) L: Lead Free Plating, Blank: Pb/Sn

■ MARKING



■ PIN CONFIGURATION



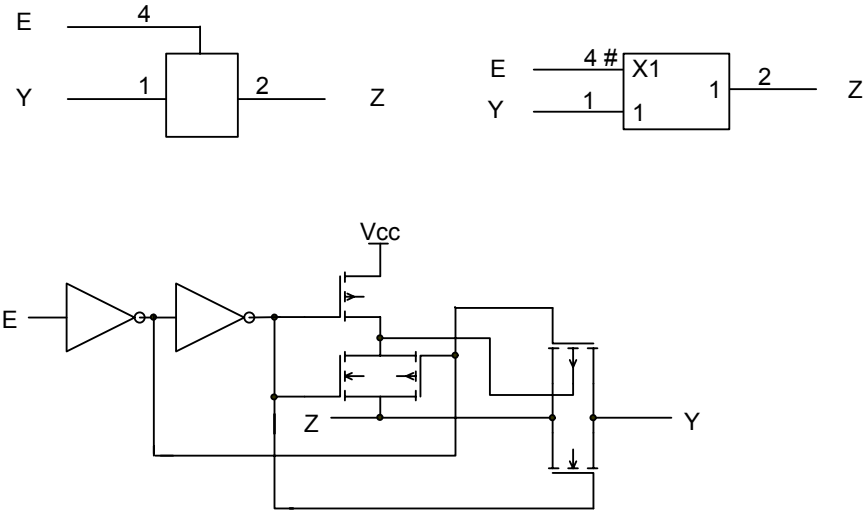
■ PIN DESCRIPTION

PIN NUMBER	SYMBOL	DESCRIPTION
1	Y	independent input/output
2	Z	independent output/input
3	GND	ground
4	E	enable input
5	Vcc	supply voltage

■ FUNCTION TABLE (each gate)

INPUT E	SWITCH
H	ON
L	OFF

■ LOGIC DIAGRAM (positive logic)



■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)(Note 1)

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage	V_{CC}	-0.5~7	V
Enable Input Voltage	V_E	-0.5~7	V
Enable Input Clamp Current	I_{EK}	-20	mA
Switch Diode Current	I_{SK}	±20	mA
On-State Switch Current(-0.5V<Vos<Vcc+0.5V)	I_S	±25	mA
V_{CC} or GND Current	I_{CC}	±75	mA
Power Dissipation	P_D	250	mW
Storage Temperature	T_{STG}	-65 ~ +150	℃

Note 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
3. To avoid drawing Vcc current out of pin Z, when switch current flows into pin Y, the voltage drop across the bidirectional switch must not exceed 0.4V. If the switch current flows into pin Z, no Vcc current will flow out of pin Y. In this case there is no limit for the voltage drop across the switch, but the voltage at pins Y and Z may not exceed Vcc or GND.

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Supply Voltage	V_{CC}		2	5.0	5.5	V
Enable Input Voltage	V_E		0		5.5	V
Switch Voltage	V_S		0		V_{CC}	V
Input Transition Rise or Fall Rate	$\Delta t/\Delta v$	V_{CC}=3.3+0.3V			100	ns/V
		V_{CC}=5.0+0.5V			20	
Operating Temperature	T_A		-40	25	125	℃

■ STATIC CHARACTERISTICS

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Input Voltage	High-Level	V_{IH}	V_{CC}=2.0V	1.5			V
			V_{CC}=3.0V	2.1			
			V_{CC}=5.5V	3.85			
	Low-Level	V_{IL}	V_{CC}=2.0V			0.5	V
			V_{CC}=3.0V			0.9	
			V_{CC}=5.5V			1.65	
Enable Input Leakage Current		$I_{E(LEAK)}$	V_{CC}=5.5V, V_E =V_{CC} or GND			0.1	μA
State Switch Current	OFF	I_S	V_{CC}=5.5V, $\|V_s\|$=V_{CC} -GND			0.1	μA
	ON		V_{CC}=5.5V			0.1	μA
ON-Resistance (Peak)		$R_{ON(PEAK)}$ (Note 4)	V_{CC}=2.0V, V_{IS}= V_{CC} to GND, I_S=1mA		148		Ω
			V_{CC}=3.0V~3.6V, V_{Is}= V_{CC} to GND, I_S=10mA		28	50	
			V_{CC}=4.5V~5.5V, V_{Is}= V_{CC} to GND, I_S=10mA		15	30	
ON-Resistance (Rail)		$R_{ON(RAIL)}$	V_{CC}=2.0V, V_{IS} = V_{CC}, I_S=1mA		28		Ω
			V_{CC}=2.0V, V_{IS} = GND, I_S=1mA		30		
			V_{CC}=3.0V~3.6V, V_{IS} = V_{CC}, I_S=10mA		18	50	Ω
			V_{CC}=3.0V~3.6V, V_{IS} = GND, I_S=10mA		20	50	
			V_{CC}=4.5V~5.5V, V_{IS}= V_{CC}, I_S=10mA		13	22	Ω
			V_{CC}=4.5V~5.5V, V_{IS}= GND, I_S=10mA		15	22	
Quiescent Supply Current		I_Q	V_{CC}=5.5V,V_E =V_{CC} or GND,V_{IS}= GND or V_{CC}, V_{OS}=V_{CC} or GND			1.0	μA
Enable Input Capacitance		C_E	V_E=V_{CC} or GND		2	10	pF
Maximum Switch Capacitance		C_S	Independent I/O		4	10	pF

Note 4. With supply voltages at or near 2V, the analog switch on-state resistance becomes very nonlinear. Only digital signals should be transmitted at these low supply voltages.

■ DYNAMIC CHARACTERISTICS (T_A=25°C)

Input: t_R, t_F≤3ns; PRR≤1MHz, All typical values are measured at Vcc=2V; Vcc=3.3V or Vcc=5V.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Propagation Delay From Y/Z TO Z/Y	t_{PHL} /t_{PLH}	V_{CC} =2.0V, C_L =50pF		2.2	5	ns
Turn-On Time From E TO Z/Y	t_{PZH} /t_{PZL}	V_{CC} =2.0V, C_L =15pF		7	25	ns
		V_{CC} =2.0V, C_L =50pF		11	35	
Turn-Off Time From E TO Z/Y	t_{PHZ} /t_{PLZ}	V_{CC} =2.0V, C_L =15pF		9	25	ns
		V_{CC} =2.0V, C_L =50pF		13	35	
Propagation Delay From Y/Z TO Z/Y	t_{PHL} /t_{PLH}	V_{CC} =3.0V~3.6V, C_L =50pF		1	2	ns
Turn-On Time From E TO Z/Y	t_{PZH} /t_{PZL}	V_{CC} =3.0V~3.6V, C_L =15pF		4	11	ns
		V_{CC} =3.0V~3.6V, C_L =50pF		5.8	15	
Turn-Off Time From E TO Z/Y	t_{PHZ} /t_{PLZ}	V_{CC} =3.0V~3.6V, C_L =15pF		6	11	ns
		V_{CC} =3.0V~3.6V, C_L =50pF		8.4	15	
Propagation Delay From Y/Z TO Z/Y	t_{PHL} /t_{PLH}	V_{CC} =4.5V~5.5V, C_L =50pF		0.6	1	ns
Turn-On From E TO Z/Y	t_{PZH} /t_{PZL}	V_{CC} =4.5V~5.5V, C_L =15pF		3	8	ns
		V_{CC} =4.5V~5.5V, C_L =50pF		4.4	11	
Turn-Off Time From E TO Z/Y	t_{PHZ} /t_{PLZ}	V_{CC} =4.5V~5.5V, C_L =15pF		5	8	ns
		V_{CC} =4.5V~5.5V, C_L =50pF		6.1	11	

Recommended conditions and typical values. GND=0; t_R=t_F=3ns

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Sine-Wave Distortion at f=1kHz		V_{CC}=3.0V~3.6V, $V_{IS(P-P)}$=2.5V, R_L=10kΩ, C_L=50pF		0.025		%
		V_{CC}=4.5V~5.5V, $V_{IS(P-P)}$=4.0V, R_L=10kΩ, C_L=50pF		0.015		
Sine-Wave Distortion at f=10kHz		V_{CC}=3.0V~3.6V, $V_{IS(P-P)}$=2.5V, R_L=10kΩ, C_L=50pF		0.025		%
		V_{CC}=4.5V~5.5V, $V_{IS(P-P)}$=4.0V, R_L=10kΩ, C_L=50pF		0.015		
Switch OFF Signal Feed-Through (Note 5)		V_{CC}=3.0V~3.6V, R_L=600Ω, C_L=50pF, F=1MHz		-50		dB
		V_{CC}=4.5V~5.5V, R_L=600Ω, C_L=50pF, F=1MHz		-50		
Minimum Frequency Response (-3dB) (Note 6)	f_{MAX}	V_{CC}=3.0V~3.6V, R_L=50Ω, C_L=10pF		230		MHz
		V_{CC}=4.5V~5.5V, R_L=50Ω, C_L=10pF		280		
OPERATING CHARACTERISTICS						
Power Dissipation Capacitance	Cpd	C_L=50pF, f=10MHz, V_{CC}=5		13		pF

Note 5. Adjust input voltage V_{IS} is 0dbm level (0dbm=1mW into 600Ω)

6. Adjust input voltage V_{IS} is 0dbm level at Vos for 1MHz (0dbm=1mW into 50Ω)

■ TEST CIRCUIT AND WAVEFORMS

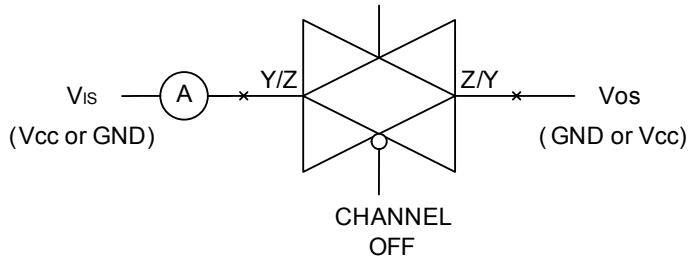


Fig-1 OFF-State Switch Leakage Current Test Circuit

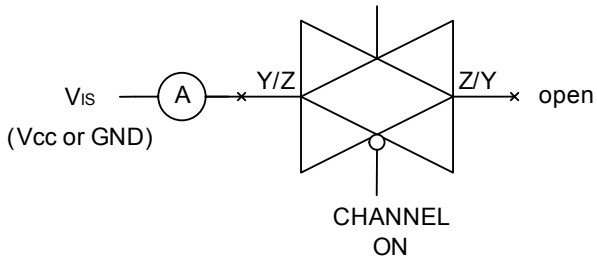


Fig-2 ON-State Leakage Current Test Circuit

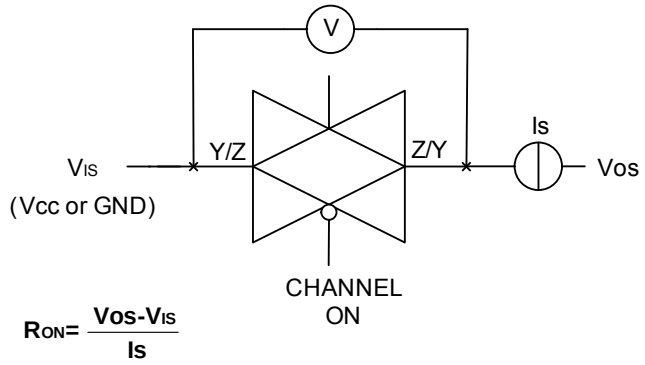


Fig-3 ON-State Resistance Test Circuit

■ TEST CIRCUIT AND WAVEFORMS(Cont.)

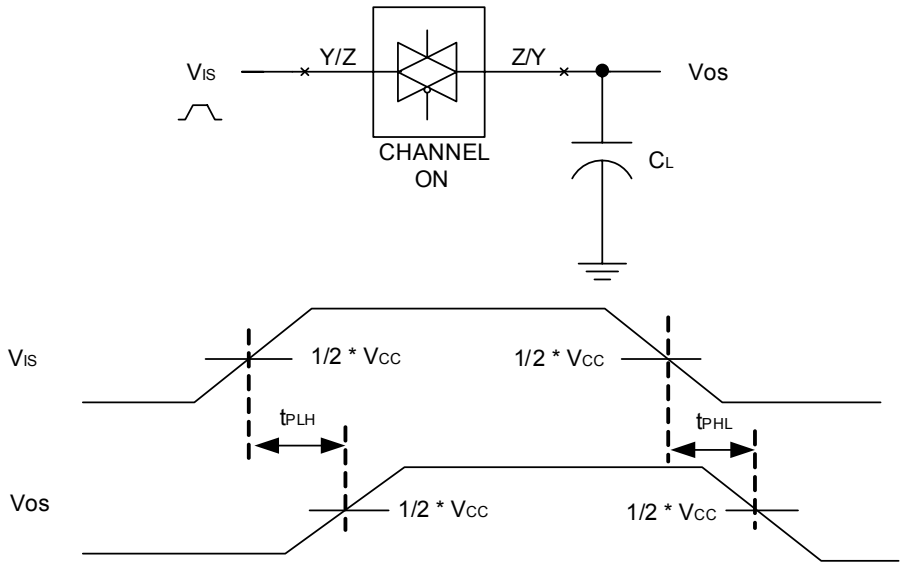


Fig-4 The input (Y/Z) to output (Z/Y) propagation delays.

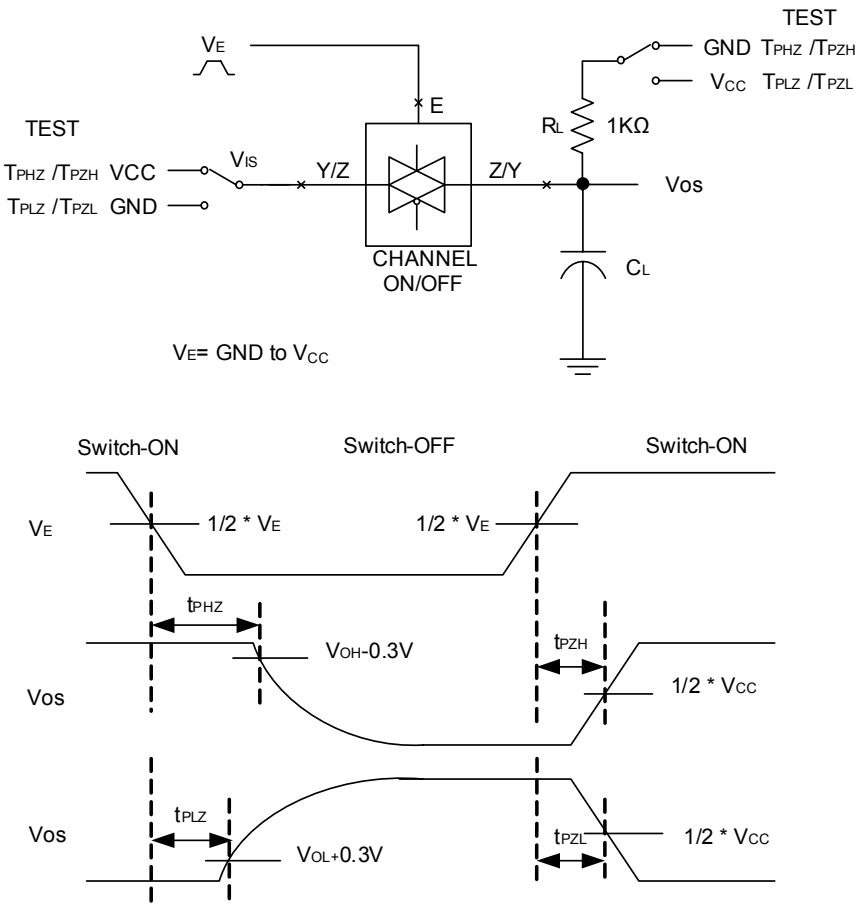


Fig-5 The switch-on and switch-off times.

■ TEST CIRCUIT AND WAVEFORMS(Cont.)

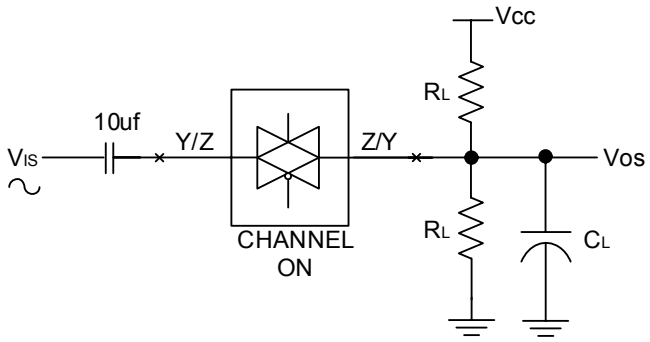


Fig-6 Sine-Wave Distortion

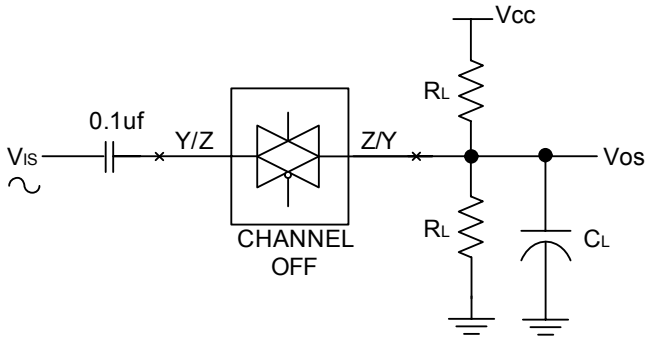


Fig-7 Feed-through Attenuation (Switch OFF)

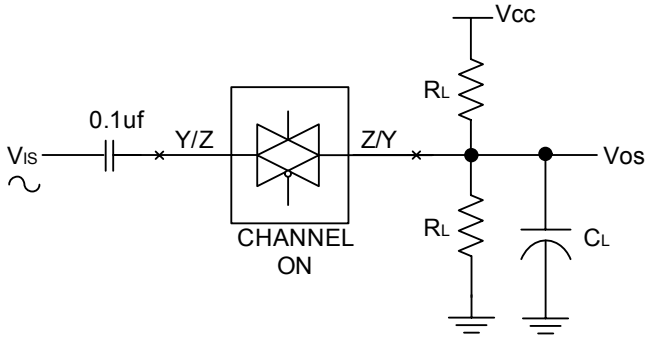


Fig-8 Minimum Frequency Response